









# PRODUCT DATASHEET



- ► PCB / CHIP LED
- ▶ 0402 (1005) 0.48t
- ► True Green 525nm

N0G58S15



# 0402 (1005) 0.48t





Release Date: 25 October 2021 Version: A1.1

0402 (1005) 0.48t

#### **APPLICATIONS:**

- Indication Light
- Switch light
- Dashboard
- Keyboard
- **Consumer Goods**

#### **FEATURES:**

- Package: PCB SMT Package Top View Single Colour
- Forward Current: 20mA Forward Voltage (typ.): 3.2V
- Luminous Intensity (typ.): 600mcd@20mA
- Colour: True Green
- Wavelength (typ.): 525nm
- Viewing angle: 120°
- **Materials:** 
  - Die: InGaN
  - Resin: Epoxy (Water Clear)
- Operating Temperature: -40~+85°C
- Storage Temperature: -40~+100°C
- **ESD:** 500V
- **Grouping parameters:** 
  - Forward voltage
  - Luminous intensity
  - **Dominant Wavelength**
- Soldering methods: Reflow
- Preconditioning: acc. to JEDEC Level 3
- Packing: 8mm tape with max.3000/reel, ø180mm (7")



### **CHARACTERISTICS:**

# Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Forward Current	IF	20	mA
Peak Forward Current Duty 1/10@10KHz	I <sub>FP</sub>	100	mA
Reverse Current @5V	IR	50	μΑ
Power Dissipation	PD	72	mW
Electrostatic Discharge	ESD	500	V
Operating Temperature	T <sub>OPR</sub>	-40~+85	°C
Storage Temperature	T <sub>STG</sub>	-40~+100	°C

# Electrical & Optical Characteristics (Ta=25°C)

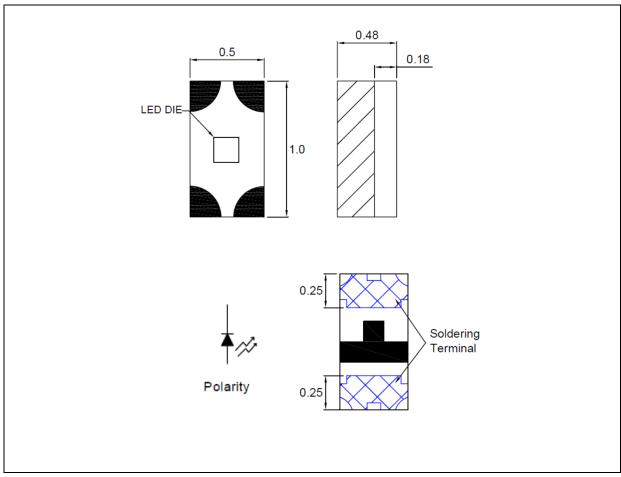
Parameter Symbol		Values			Hoit	Test
Parameter Symbo	Symbol	Min.	Тур.	Max.	Unit	Condition
Forward Voltage	VF	2.8		3.6	V	I <sub>F</sub> =20mA
Luminous Intensity	I <sub>V</sub>	320	600		mcd	I <sub>F</sub> =20mA
Dominant Wavelength	$\lambda_{D}$		525		nm	I <sub>F</sub> =20mA
Spectral Line Half Bandwidth	Δλ		36		nm	I <sub>F</sub> =20mA
Viewing Angle	2θ <sub>1/2</sub>		130		deg	I <sub>F</sub> =20mA

<sup>1.</sup> Luminous intensity ( $I_V$ ) ±15%, Forward Voltage ( $V_F$ ) ±0.1V



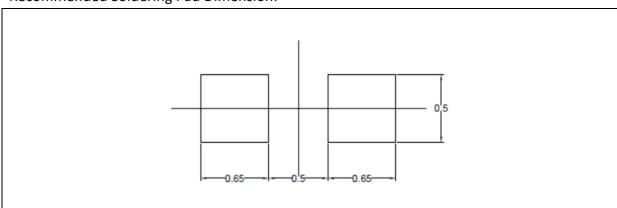
#### **OUTLINE DIMENSION:**

### Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.2mm, unless otherwise noted.

#### Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm with angle tolerance ±0.5°.



### **BINNING GROUPS:**

# Forward Voltage Classifications (I<sub>F</sub> = 20mA):

Code	Min.	Max.	Unit
1	2.8	3.0	
2	3.0	3.2	V
3	3.2	3.4	V
4	3.4	3.6	

#### Luminous Intensity Classifications (I<sub>F</sub> = 20mA):

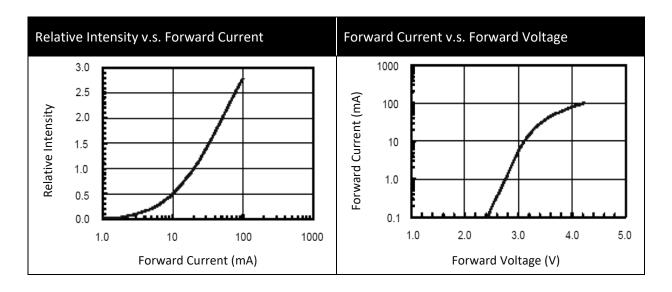
Code	Min.	Max.	Unit
Т	320	500	
U	500	800	mcd
V	800	1250	

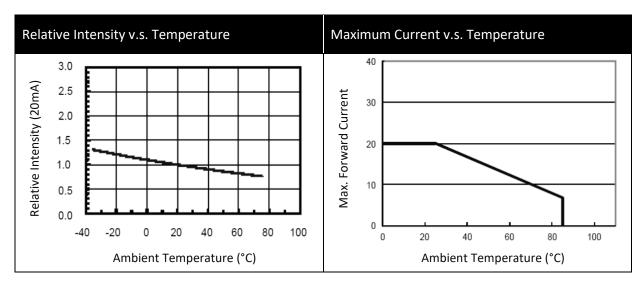
### Dominant Wavelength Classifications (IF = 20mA):

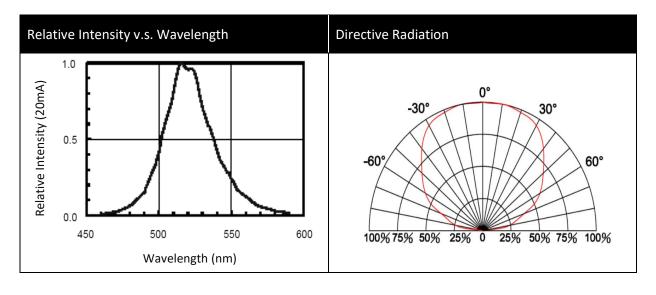
Code	Min.	Max.	Unit
10	519	522	
1P	522	525	
1Q	525	528	nm
1R	528	531	



#### **ELECTRO-OPTICAL CHARACTERISTICS:**





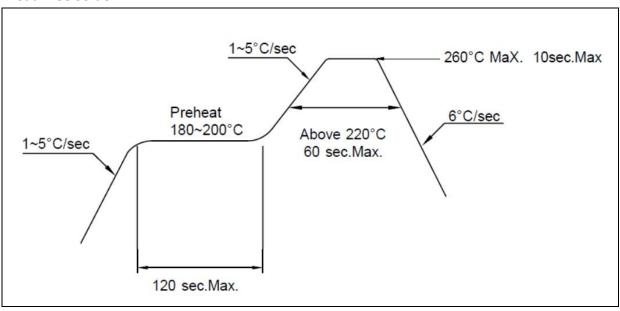


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#### **RECOMMENDED SOLDERING PROFILE:**

#### Lead-free Solder:



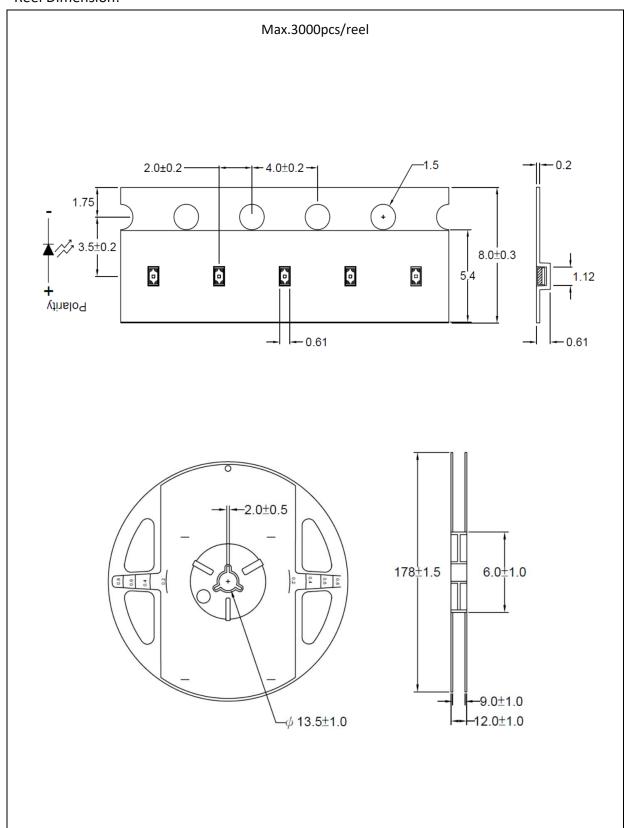
#### Note:

- 1. Maximum reflow soldering: 2 times.
- 2. Maximum soldering temperature should be limited to 260°C.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.



### **PACKING SPECIFICATION:**

#### Reel Dimension:





#### **PRECAUTIONS OF USE:**

#### Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent <10% R.H. and apply baking before use.

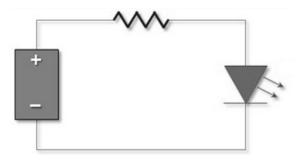
#### Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 60±3°C x 72hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

#### **Testing Circuit:**



Must apply resistor(s) for protection (over current proof).

#### Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

#### ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



# **REVISION RECORD:**

Version	Date	Summary of Revision
A1.0	20/07/2020	Datasheet set-up.
A1.1	25/10/2021	New datasheet format.